

### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO220F Pin Configuration



### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	60	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	38	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	240	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	181	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	60.1	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	40.3	W
	Power Dissipation – Derate above $25^\circ\text{C}$	0.32	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	3.1	$^\circ\text{C/W}$

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	60	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$	---	0.036	---	$\text{V}/^\circ\text{C}$
$I_{\text{DS}}^{\text{SS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=60\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=48\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance <sup>3</sup>	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$	---	5.1	6	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=10\text{A}$	---	5.9	7.5	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$	1.2	1.6	2.5	V
			---	-5.08	---	$\text{mV}/^\circ\text{C}$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=3\text{A}$	---	15	---	S

**Dynamic and switching Characteristics**

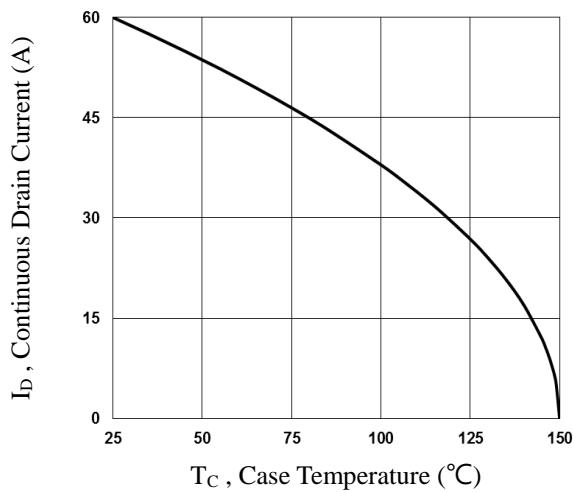
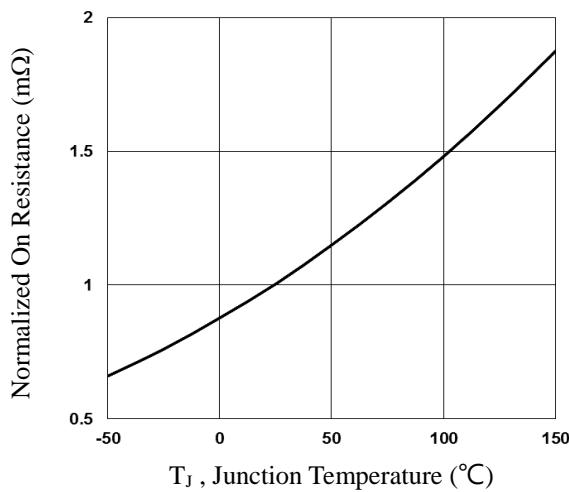
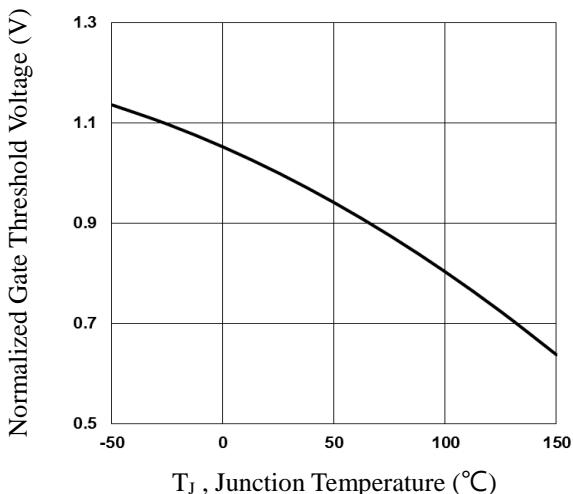
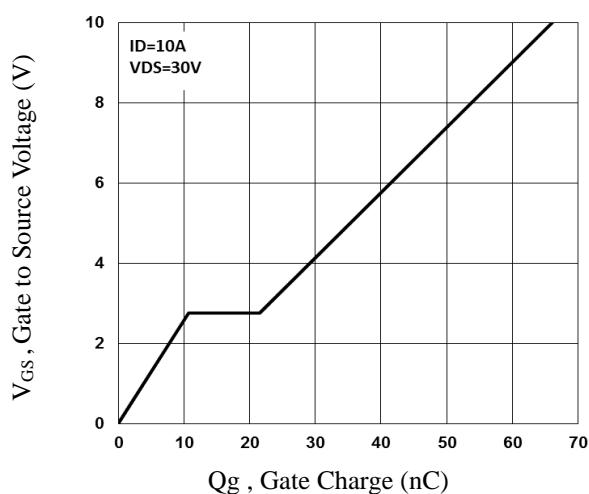
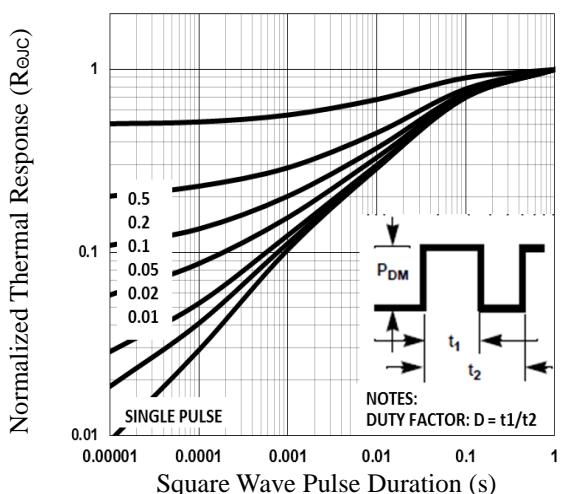
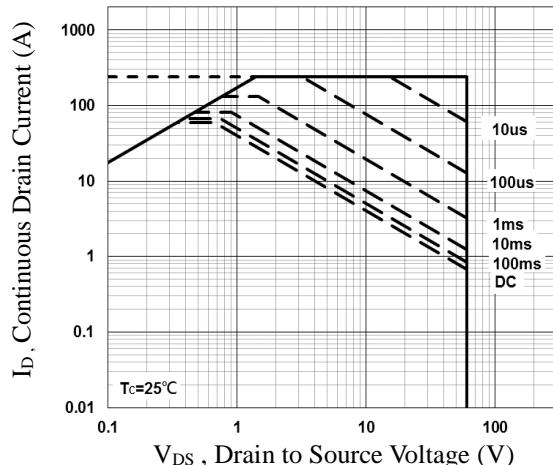
$Q_g$	Total Gate Charge <sup>3, 4</sup>	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=10\text{A}$	---	32.8	65	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>3, 4</sup>		---	10.8	20	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>3, 4</sup>		---	11.6	22	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>3, 4</sup>	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_{\text{G}}=3.3\Omega$	---	20	40	ns
$T_r$	Rise Time <sup>3, 4</sup>		---	14.2	28	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>3, 4</sup>		---	61.2	122	
$T_f$	Fall Time <sup>3, 4</sup>		---	16.8	34	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	4740	7110	pF
$C_{\text{oss}}$	Output Capacitance		---	325	488	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	161	332	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	1.6	---	$\Omega$

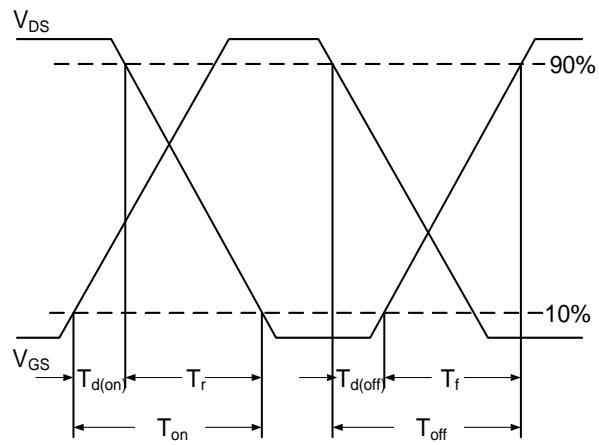
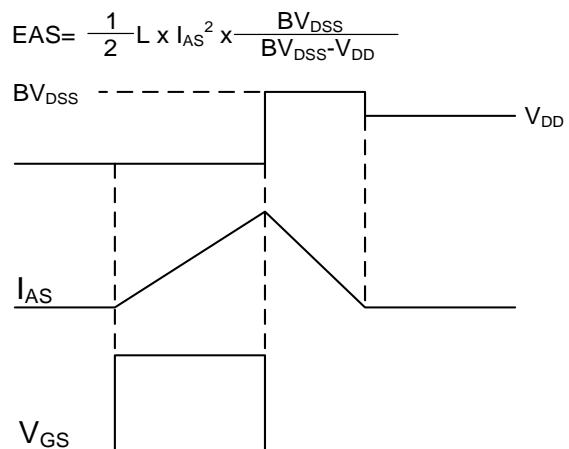
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	60	A
$I_{\text{SM}}$	Pulsed Source Current <sup>3</sup>		---	---	120	A
$V_{\text{SD}}$	Diode Forward Voltage <sup>3</sup>	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

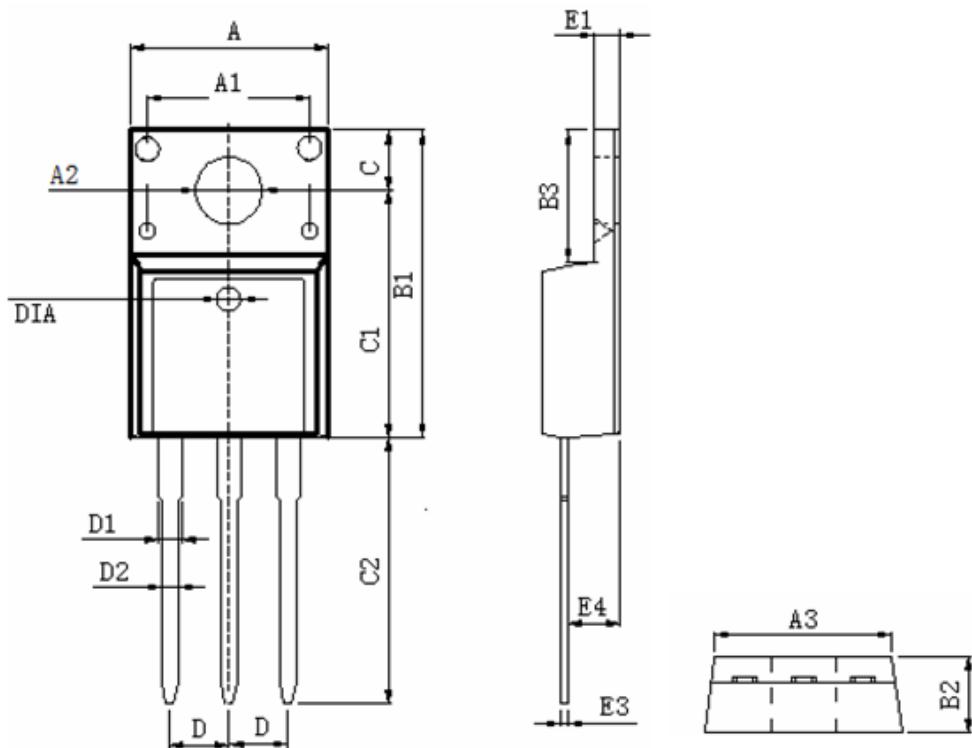
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=60.1\text{A}$ ,  $R_{\text{G}}=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs.  $T_C$** 

**Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$** 

**Fig.3 Normalized  $V_{th}$  vs.  $T_J$** 

**Fig.4 Gate Charge Waveform**

**Fig.5 Normalized Transient Response**

**Fig.6 Maximum Safe Operation Area**


**Fig.7 Switching Time Waveform**

**Fig.8 EAS Waveform**

## TO220F PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	<b>10.460</b>	<b>9.860</b>	<b>0.412</b>	<b>0.388</b>
A1	<b>7.100</b>	<b>6.900</b>	<b>0.280</b>	<b>0.272</b>
A2	<b>3.500</b>	<b>3.100</b>	<b>0.138</b>	<b>0.122</b>
A3	<b>9.900</b>	<b>9.500</b>	<b>0.390</b>	<b>0.374</b>
B1	<b>16.170</b>	<b>15.570</b>	<b>0.637</b>	<b>0.613</b>
B2	<b>4.900</b>	<b>4.500</b>	<b>0.193</b>	<b>0.177</b>
B3	<b>6.880</b>	<b>6.480</b>	<b>0.271</b>	<b>0.255</b>
C	<b>3.500</b>	<b>3.100</b>	<b>0.138</b>	<b>0.122</b>
C1	<b>12.870</b>	<b>12.270</b>	<b>0.507</b>	<b>0.483</b>
C2	<b>13.380</b>	<b>12.580</b>	<b>0.527</b>	<b>0.495</b>
D	<b>2.590</b>	<b>2.490</b>	<b>0.102</b>	<b>0.098</b>
D1	<b>1.470</b>	<b>1.070</b>	<b>0.058</b>	<b>0.042</b>
D2	<b>0.900</b>	<b>0.700</b>	<b>0.035</b>	<b>0.028</b>
E1	<b>2.740</b>	<b>2.340</b>	<b>0.108</b>	<b>0.092</b>
E3	<b>0.600</b>	<b>0.400</b>	<b>0.024</b>	<b>0.016</b>
E4	<b>2.960</b>	<b>2.560</b>	<b>0.117</b>	<b>0.101</b>
DIA	<b>Φ1.5 TYP.</b>	<b>deep0.1 TYP.</b>	<b>Φ0.059 TYP.</b>	<b>deep0.004 TYP.</b>